

H5N2515P

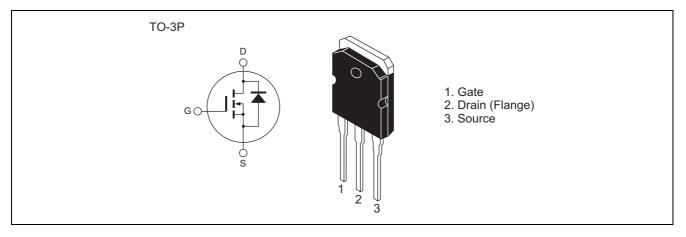
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G0413-0100 Rev.1.00 Sep.28.2004

Features

- Low on-resistance
- Low leakage current
- www.DataSheet4U.High speed switching

Outline



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to Source voltage	V _{DSS}	250	V
Gate to Source voltage	V _{GSS}	±30	V
Drain current	I _D	55	А
Drain peak current	I _{D (pulse)} Note1	165	А
Body-Drain diode reverse Drain current	I _{DR}	55	А
Body-Drain diode reverse Drain peak current	I _{DR (pulse)} Note1	165	A
Avalanche current	I _{AP} ^{Note3}	19	А
Avalanche energy	E _{AR} ^{Note3}	22.5	mJ
Channel dissipation	Pch ^{Note2}	200	W
Channel to case thermal impedance	θch-c	0.625	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tc = $25^{\circ}C$

3. STch = 25° C, Tch $\leq 150^{\circ}$ C



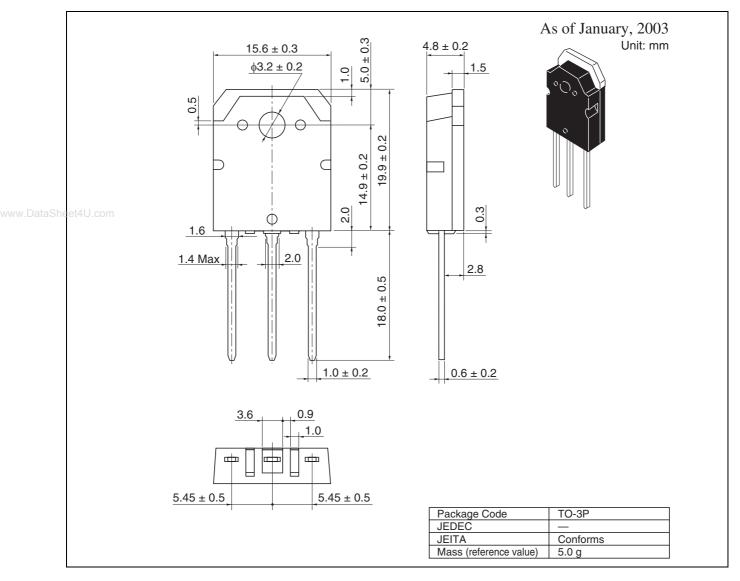
Electrical Characteristics

						$(Ta = 25^{\circ}C)$	
Item	Symbol	Min	Тур	Max	Unit	Test conditions	
Drain to Source breakdown voltage	V _{(BR)DSS}	250	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$	
Zero Gate voltage Drain current	I _{DSS}	—	—	1	μΑ	$V_{DS} = 250 \text{ V}, \text{ V}_{GS} = 0$	
Gate to Source leak current	I _{GSS}		—	±0.1	μΑ	$V_{GS}=\pm 30~V,~V_{DS}=0$	
Gate to Source cutoff voltage	V _{GS(off)}	3.0	—	4.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$	
Forward transfer admittance	yfs	23	39	—	S	$I_D = 27.5 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$	
Static Drain to Source on state resistance	R _{DS(on)}		0.039	0.044	Ω	$I_D = 27.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$	
Input capacitance	Ciss	_	3800	_	pF	V _{DS} = 25 V	
Output capacitance	Coss	_	530	_	pF	V _{GS} = 0 f = 1 MHz	
Reverse transfer capacitance	Crss	_	56	—	pF		
Turn-on delay time	t _{d(on)}	_	50	—	ns	$I_{D} = 27.5 \text{ A} \\ V_{GS} = 10 \text{ V} \\ R_{L} = 4.55 \Omega \\ \text{Rg} = 10 \Omega$	
Rise time	tr	_	240	—	ns		
Turn-off delay time	t _{d(off)}	_	170	—	ns		
Fall time	t _f		170	—	ns		
Total Gate charge	Qg	_	92	—	nC	$V_{DD} = 200 V$ $V_{GS} = 10 V$ $I_D = 55 A$	
Gate to Source charge	Qgs		24	—	nC		
Gate to Drain charge	Qgd		38	—	nC		
Body-Drain diode forward voltage	V _{DF}		1.03	1.60	V	$I_F = 55 \text{ A}, V_{GS} = 0^{Note4}$	
Body-Drain diode reverse recovery time	trr		200	_	ns	I _F = 55 A, V _{GS} = 0	
Body-Drain diode reverse recovery charge	Qrr	—	1.4	—	μC	diF/dt = 100 A/µs	

Notes: 4. Pulse test



Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container		
H5N2515P-E	30 pcs	Plastic magazine		

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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